

Solid State Relay OCMOS FET

PS7241E-1B

4-PIN SOP 400 V BREAK DOWN VOLTAGE NORMALLY CLOSE TYPE 1-ch Optical Coupled MOS FET

DESCRIPTION

The PS7241E-1B is an optically coupled element that combines a GaAs infrared LED on the input side with a normally close MOS FET on the output side to realize an excellent cost performance.

The small, thin package and high sensitivity of this element makes it ideal for battery-driven mobile devices, and its small offset voltage at power-on and good linearity also make it suitable for controlling micro analog signals.

FEATURES

- Small and thin package (4-pin SOP, Height = 2.1 mm)
- 1 channel type (1 b output)
- Designed for AC/DC switching line changer
- Low offset voltage
- Ordering number of taping product: PS7241E-1B-E3, E4, F3, F4
- · Pb-Free product
- · UL awaiting approval
- · BSI awaiting approval

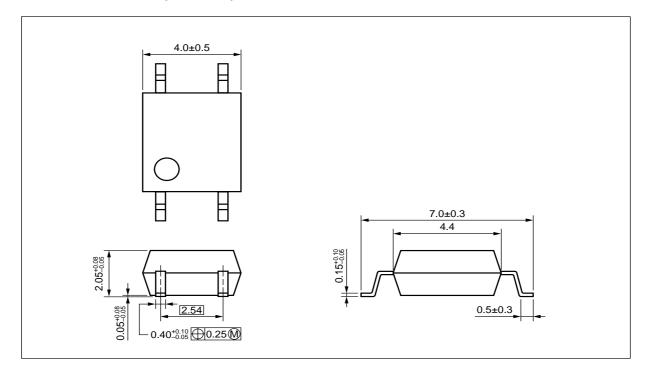
PIN CONNECTION (Top View) 4 3 1. LED Anode 2. LED Cathode 3. MOS FET 4. MOS FET

APPLICATIONS

- · Laptop PC, PDA
- Modem card
- Telephone, FAX
- · Measurement equipment

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PACKAGE DIMENSIONS (UNIT: mm)





ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS7241E-1B	PS7241E-1B-A	Pb-Free*2	Magazine case 100 pcs	UL and BSI	PS7241E-1B
PS7241E-1B-E3	PS7241E-1B-E3-A		Embossed Tape 900 pcs/reel	awaiting approval	
PS7241E-1B-E4	PS7241E-1B-E4-A				
PS7241E-1B-F3	PS7241E-1B-F3-A		Embossed Tape 3 500 cs/reel		
PS7241E-1B-F4	PS7241E-1B-F4-A				

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)	lF	50	mA	
	Reverse Voltage	VR	5.0	V	
	Power Dissipation	PD	50	mW	
	Peak Forward Current *1	IFP	1	Α	
MOS FET	MOS FET Break Down Voltage		400	V	
	Continuous Load Current	lι	120	mA	
	Pulse Load Current ^{*2} (AC/DC Connection)	ILP	240	mA	
	Power Dissipation	Po	300	mW	
Isolation Voltage*3		BV	1 500	Vr.m.s.	
Total Power Dissipation		Рт	350	mW	
Operating Ambient Temperature		TA	-40 to +85	°C	
Storage Temperature		T _{stg}	-40 to +100	°C	

^{*1} PW = 100 μ s, Duty Cycle = 1%

^{*2} With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

^{*2} PW = 100 ms, 1 shot

^{*3} AC voltage for 1 minute at $T_A = 25$ °C, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.



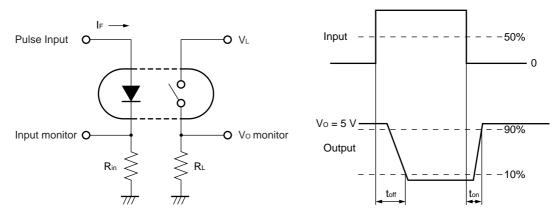
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	3	10	20	mA
LED Off Voltage	VF	0		0.5	V

ELECTRICAL CHARACTERISTICS (TA = 25°C)

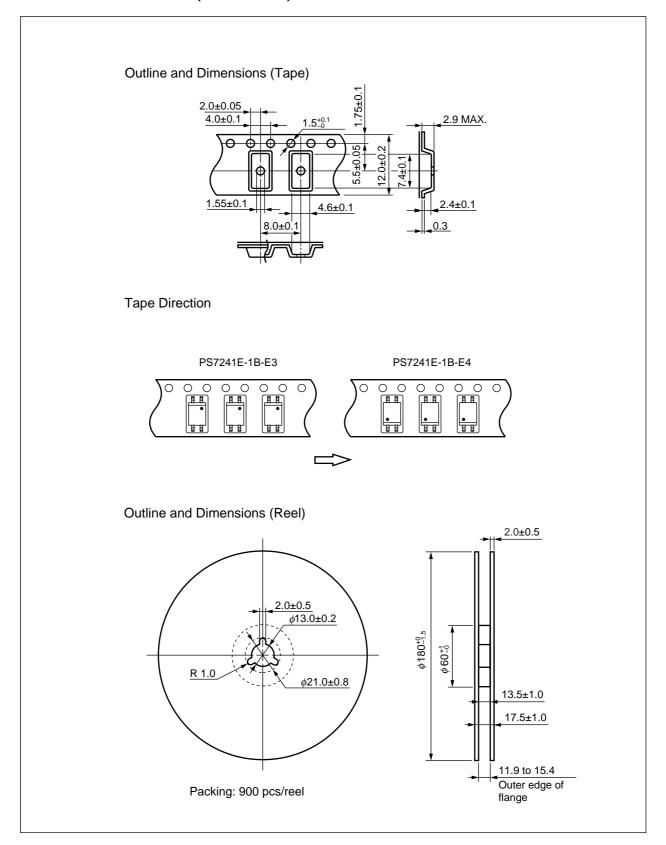
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode Forward Voltage		VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	lr	V _R = 5 V			5.0	μА
MOS FET	Off-state Leakage Current	Loff	I _F = 10 mA, V _D = 400 V			1.0	μА
	Output Capacitance	Cout	IF = 10 mA, VD = 0 V, f = 1 MHz		206		pF
Coupled	LED Off-state Current	I Foff	IL = 120 mA			3.0	mA
	On-state Resistance	R _{on1}	IF = 0 mA, IL = 10 mA		22	35	Ω
		Ron2	$I_F = 0 \text{ mA}, I_L = 120 \text{ mA}, t \le 10 \text{ ms}$		17	24	
	Turn-on Time*1	ton	If = 10 mA, Vo = 5 V, RL = 500 Ω ,		0.07	0.2	ms
	Turn-off Time*1	toff	PW ≥ 10 ms		1.0	3.0	
	Isolation Resistance	R _I -o	Vi-o = 1.0 kVpc	10 ⁹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.5		pF

*1 Test Circuit for Switching Time

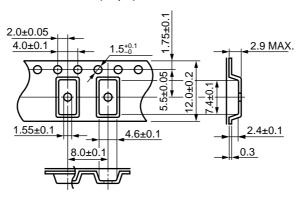




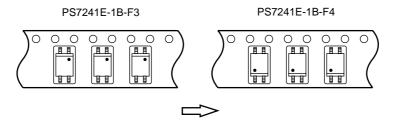
TAPING SPECIFICATIONS (in millimeters)



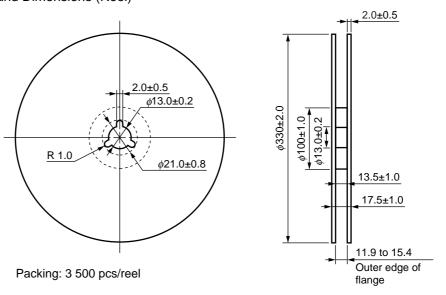
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



PS7241E-1B NEC

RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

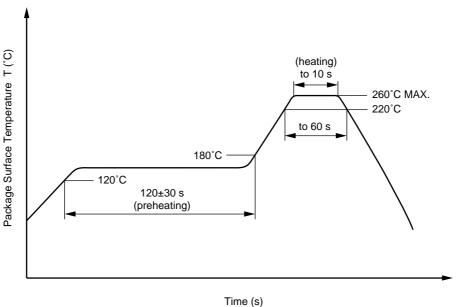
10 seconds or less • Time of peak reflow temperature • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

NEC PS7241E-1B

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M8E 00.4-0110

NEC PS7241E-1B

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
 - 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

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